

Product Description

- The 0805 SMD LED is much smaller, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- These LEDs have high reliability performance and are designed to work under a wide range of environmental conditions.
- Besides, lightweight makes them ideal for miniature applications. etc.

Features

- · Size(mm): 2.0*1.25*0.85mm
- · Compatible with automatic placement equipment
- · Moisture Sensitivity Level: 3
- · Color type: White
- · Viewing Angle:120°
- · Pb-free
- · RoHS and REACH compliant

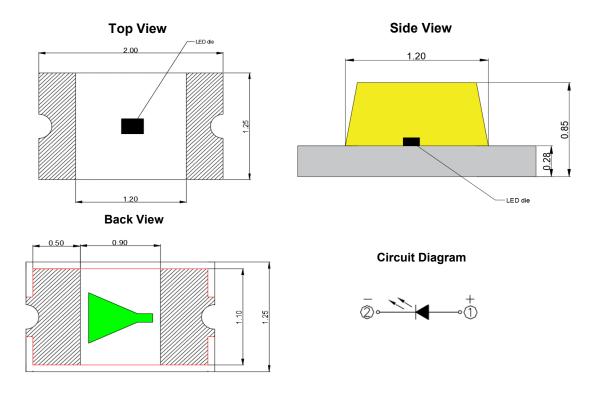
Applications

- Backlighting in dashboard and switch.
- Digital display for household appliace
- Telecommunication: indicator and backlighting in telephone and fax.
- · Flat backlight for LCD
- · General use



MECHANICAL DIMENSIONS

All dimensions are in mm.



Remark

The tolerance of all dimensions above is 0.1mm.



ABSOLUTE MAXIMUM RATINGS $(T_A = 25^{\circ}C)$

Items	Symbol	Symbol Absolute Maxium Rating	
Forward current	l _F	20	mA
Peak Forward Crurrent	I _{FP}	60	mA
Reverse voltage	V_{R}	5	V
Power dissipation	P_{D}	100	mW
Operating temperature	T_{opr}	T _{opr} -40 ~+85	
Storage temperature	T_{stg}	-40~+100	${\mathbb C}$

Remark: 1/10 Duty cycle, 0.1ms pulse width.

TYPICAL ELECTRICAL & OPTICAL CHARACTERISTICS ($T_A = 25$ °C)

Charateristics	Symbol	Condition	Unit	Minimum	Typical
Forward Volatge	V_{F}	I _F =5mA	V		2.8
Reverse Current	V_R	V _R =5V	uA		<1
Viewing Angle	2θ _{1/2}	I _F =5mA			120
Luminous intensity	l _V	I _F =5mA	mcd	175	
Spectral Line Half-Width	Δλ		nm		15
Chromaticity Coordinate	х	I _F =5mA			0.2500
	у	I _F =5mA			0.2300
Color Temperature	ССТ	IF=5mA	К	12000	

^{*} Continuous reverse voltage can cause LED damage.

INTENSITY BIN LIMIT

White (5mA)			
Bin code	Min.(mcd)	Max.(mcd)	
WM1	175	210	
WM2	210	250	
WM3	250	300	
WM4	300	360	
WM5	360	430	

^{*}Tolerance of measurement of luminous intensity is ±10%.



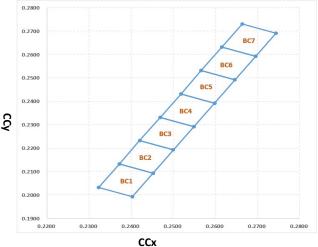
VOLTAGE BIN LIMIT

White (5mA)			
Bin code	Min.(V)	Max.(V)	
WV1	2.6	2.7	
WV2	2.7	2.8	
WV3	2.8	2.9	
WV4	2.9	3.0	

^{*}Tolerance of measurement of voltage is ±0.05V.

CHROMATICITY DIAGRAM

Bin Code	CCT	CCx	ССу	l
BC1		0.2403	0.1993	
	>100000	0.2323	0.2032	
ВСТ	>100000	0.2372	0.2132	
		0.2452	0.2093	
	76621-100000	0.2452	0.2093	
BC2		0.2372	0.2132	
ВС2	70021-100000	0.242	0.2232	
		0.25	0.2193	
		0.25	0.2193	
BC3	39495-76621	0.242	0.2232	
BC3	39493-70021	0.2469	0.2331	
		0.2549	0.2292	ç
	25476-39495	0.2549	0.2292	۲
BC4		0.2469	0.2331	
BC4		0.2518	0.2431	
		0.2598	0.2392	
	18795-25476	0.2598	0.2392	
BC5		0.2518	0.2431	
500		0.2566	0.2531	
		0.2646	0.2492	
BC6	15000-18795	0.2646	0.2492	
		0.2566	0.2531	*
		0.2615	0.2631	
		0.2695	0.2592	
		0.2695	0.2592	
		0.2615	0.2631	
BC7	12621-15000	0.2664	0.273	
		0.2744	0.2691	
		0.2403	0.1993	

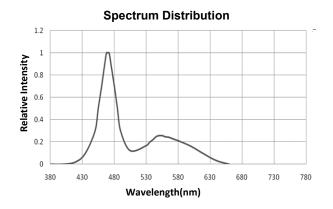


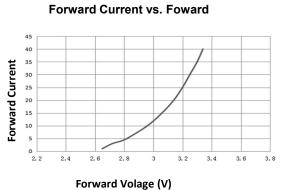
*Tolerance of measurement of the color coordinates is ±0.005

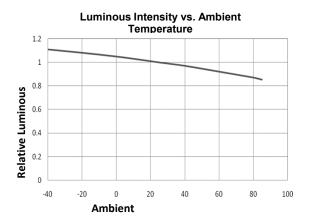


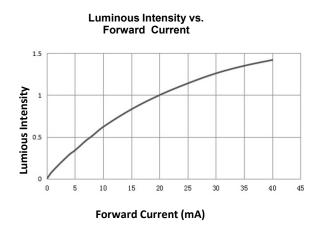
TYPICAL ELECTRO-OPTICAL CHARATERISTICS CURES(Ta=25°C)

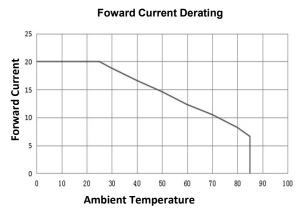
The data below are collected from statistical figures that do not necessarily correspond to the actual parameters of each single LED. Hence, these data will be changed without further notice.

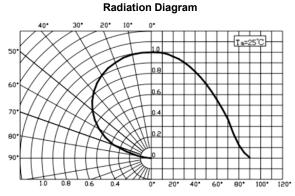








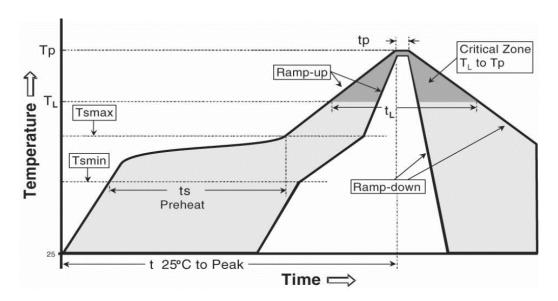






REFLOW SOLDERING

- The CHIP LED is rated as a MSL3 as general request product.
- · The recommended floor life out of bag is 24hrs.
- The temperature profile is as below.



IPC/JEDEC J-STD-020C

Profile Feature	Pb-Free Assembly
Average ramp-up rate(Tsmax to Tp)	3°C/second max.
Preheat	
- Temperature Min(Ts _{min})	150℃
- Temperature Max(Ts _{max})	200℃
- Time(Tsmin to Ts _{max})	60-180 seconds
Time mainted above	
- Temperature(T _L)	217℃
- Time(T _L)	60-150 seconds
Peak Temperature(Tp)	260℃
Time within 5°C of actual peak Temperature(tp) ²	20-40 seconds
Ramp-down Rate	6°C/second max.
Time 25°C to peak Temperature	8 minutes max.



Moisture Sensitivity

- · Beking recommends keeping CHIP LEDs in the provided, resealable moisture-barrier packaging (MBP) until immediately prior to soldering. Unopened MBPs that contain CHIP LEDs do not need special storage for moisture sensitivity.
- \cdot Once the MBP is opened, CHIP LEDs may be stored as MSL 3 per IPC/JEDEC J-STD-020C, meaning they have one year of floor life in conditions of ≤ 30 °C/60% relative humidity (RH). Regardless of the storage condition, Beking LED recommends sealing any unsoldered CHIP LEDs in the original MBP.

Handling

- ·The packaging sizes of these SMD products are very small. Users are required to handle with care.
- To avoid damaging the product's surface and interior device, it is recommended to choose a

Repairing

Repair should not be recommended after SMT production. When repairing is needed, a double-head soldering iron should be used (as below figure). It should be assured before handing whether the electrical and optical characteristics of the LEDs will or will not be damaged by



Fig.1 Pickig up a LED using an tweezer with care

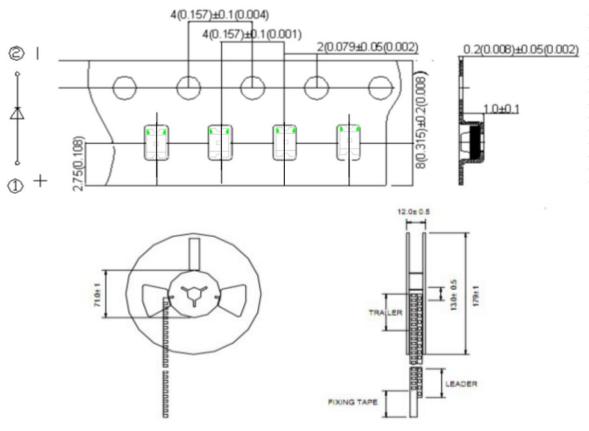


Fig2. Repairing using a double-head soldering iron



PACKING

Carrier Tape Dimensions: Loaded quantity 3000pcs per reel.



All dimensions are in millimeters.

Tolerance of measurement of all dimensions is ± 0.1 mm

